

4

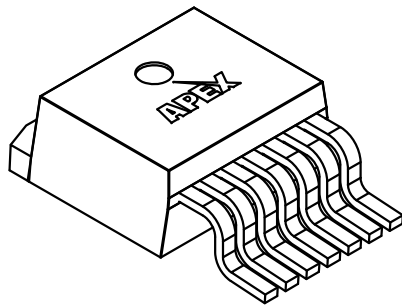
3

2

1

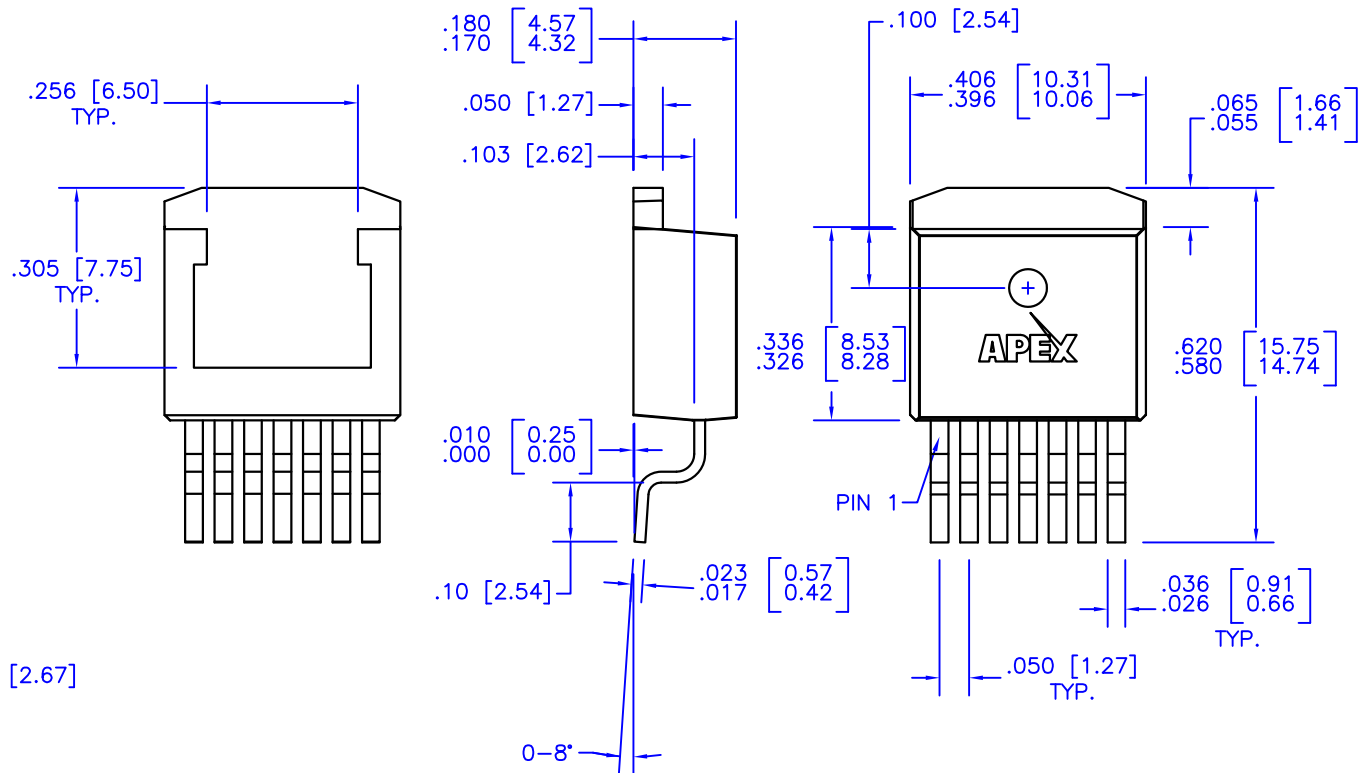
D

D



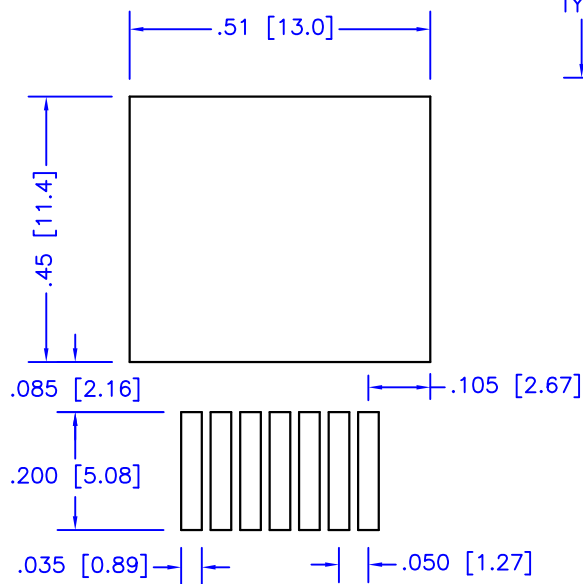
C

C



B

B



Surface Mount Layout

NOTES:

1. Dimensions are in inches & [mm].
2. Mold compound: MPC8000CH epoxy
3. Pins & Heat Slug: HCL-12S Cu alloy, 100% MATTE Sn FINISH
4. Package weight: .051 oz. [1.46 g]
5. Suggested surface mount layout for reference only.

A

A

TOLERANCES - UNLESS
OTHERWISE SPECIFIED

.XX = ±.01 [.254]
.XXX = ±.005 [.127]
ANG. = ±5°



TITLE:

7-pin DDPACK, SMT

MODEL:

CC

SUBJECT:

PACKAGE OUTLINE

ENGINEER:

DAG R.MOR

DCA:

13225

SHL:

1

OF

1

FILENAME:

CC

REV:

D

DATE:

29MAY13

4

3

2

1